

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



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**Field Device Integration (FDI) –  
Part 3: FDI Server**

**Intégration des appareils de terrain (FDI) –  
Partie 3: Serveur FDI**



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IEC 62769-3

Edition 1.0 2015-05

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INTERNATIONAL  
ELECTROTECHNICAL  
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ICS 25.040.40; 35.100

ISBN 978-2-8322-2639-1

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## CONTENTS

FOREWORD.....	5
INTRODUCTION.....	7
1 Scope.....	8
2 Normative references .....	8
3 Terms, definitions, abbreviated terms and acronyms .....	9
3.1 Terms and definitions.....	9
3.2 Abbreviated terms and acronyms .....	9
4 Overview .....	9
5 Information Model.....	10
5.1 General.....	10
5.2 Online/Offline.....	11
5.2.1 Overview .....	11
5.2.2 Transfer to device.....	11
5.2.3 Transfer from device.....	11
5.3 Access privileges .....	12
5.4 Private Parameters .....	12
5.5 Locking.....	12
5.6 EditContext.....	13
5.6.1 Concept and usage model .....	13
5.6.2 Services .....	14
5.6.3 NodeIds.....	15
5.6.4 Reading.....	15
5.6.5 Writing.....	15
5.6.6 Writing dominant and dependent Variables .....	16
5.6.7 Actions (EDD METHODS).....	16
5.6.8 UIDs .....	17
5.6.9 Synchronization.....	17
5.7 Reading .....	17
5.7.1 General .....	17
5.7.2 Reading offline variables .....	18
5.7.3 Reading online variables .....	19
5.8 Writing.....	20
5.8.1 General .....	20
5.8.2 Write offline variables .....	20
5.8.3 Writing online variables .....	21
5.8.4 Writing to an EditContext .....	23
5.9 Subscription.....	24
5.9.1 General .....	24
5.9.2 Subscription of offline variables .....	24
5.9.3 Subscription of online variables .....	25
5.10 Device topology .....	27
5.10.1 General .....	27
5.10.2 Connection Points .....	27
5.10.3 Topology management .....	28
5.10.4 Topology scanning.....	31
5.10.5 Use of SCAN function.....	32

5.10.6	Validation of defined topology.....	32
5.11	User Interface Elements.....	33
5.11.1	User Interface Descriptions.....	33
5.11.2	User Interface Plug-ins .....	34
5.12	Actions .....	34
5.12.1	FDI Server – FDI Client interaction .....	34
5.12.2	Action state machine .....	37
5.12.3	Actions Proxies.....	38
5.12.4	Actions, EDD Actions and Actions Proxies.....	39
6	OPC UA services.....	40
6.1	OPC UA profiles .....	40
6.2	Service error information.....	40
6.2.1	Overview .....	40
6.2.2	OPC UA services and their response.....	41
6.2.3	Mappings of EDDL response codes to OPC UA service response .....	41
6.3	Parameter value update during write service request .....	42
6.4	Localization .....	42
6.5	Audit events.....	43
7	Communication.....	43
7.1	Notation .....	43
7.2	General.....	43
7.2.1	Concepts .....	43
7.2.2	Terms .....	45
7.3	Communication Service processing.....	46
7.3.1	Communication Service invocation .....	46
7.3.2	Analyze communication path .....	46
7.3.3	Manage communication relations.....	47
7.3.4	Communication service request mapping.....	47
7.3.5	Communication service request propagation.....	48
7.3.6	Communication error handling .....	49
7.4	FDI Communication Server specific handling .....	49
7.4.1	Discovery .....	49
7.4.2	Information Model synchronization.....	50
8	Parallel Execution within the FDI Server .....	50
8.1	Motivation .....	50
8.2	Internal structure of the EDD interpreter.....	50
8.3	Rules for running an EDD entity.....	51
Annex A (informative)	FDI Server functional structure .....	52
A.1	FDI functional elements .....	52
A.2	FDI Server extension .....	53
Annex B (informative)	Access privileges and user roles .....	55
B.1	User roles and usage case.....	55
B.2	Private data usage .....	56
Annex C (informative)	Parallel execution within the FDI Server – Examples .....	57
C.1	Simple example for a synchronous execution.....	57
C.2	Example for a concurrent execution .....	57
C.3	Deadlock detection in concurrent execution .....	59
Bibliography	.....	60

Figure 1 – FDI architecture diagram .....	8
Figure 2 – Locking services .....	13
Figure 3 – EditContext models .....	14
Figure 4 – EditContext for EDD Methods.....	17
Figure 5 – Offline variable read.....	18
Figure 6 – Online variable read.....	19
Figure 7 – Offline variable write immediate .....	21
Figure 8 – Online variable write immediate .....	22
Figure 9 – Write with EditContext.....	23
Figure 10 – Offline variable subscription .....	25
Figure 11 – Online variable subscription .....	26
Figure 12 – Topology with Network objects (non-normative) .....	27
Figure 13 – Add Device to topology .....	29
Figure 14 – Remove Device from topology.....	30
Figure 15 – Scan topology .....	31
Figure 16 – Action execution.....	36
Figure 17 – Action state machine.....	37
Figure 18 – System communication integration example .....	43
Figure 19 – FDI Communication Server integration example .....	44
Figure 20 – Gateway integration example .....	45
Figure 21 – Message propagation example scenario.....	48
Figure A.1 – Functional components of an FDI Server .....	52
Figure A.2 – FDI Server extensions .....	53
Figure B.1 – User roles and access privileges.....	55
Figure C.1 – Synchronous execution of two triggers.....	57
Figure C.2 – Concurrent execution of two triggers (step1).....	57
Figure C.3 – Concurrent execution of two triggers (step 2).....	58
Figure C.4 – Concurrent execution of two triggers (step 3).....	58
Figure C.5 – Concurrent execution of two triggers (step 4).....	58
Figure C.6 – Concurrent execution of two triggers.....	59
Table 1 – Action states .....	37
Table 2 – Action state transitions .....	38
Table 3 – EDD Action types and the EDD constructs that use them .....	39
Table 4 – OPC UA severity bits and EDDL response codes TYPE .....	41

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## FIELD DEVICE INTEGRATION (FDI) –

## Part 3: FDI Server

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CDV	Report on voting
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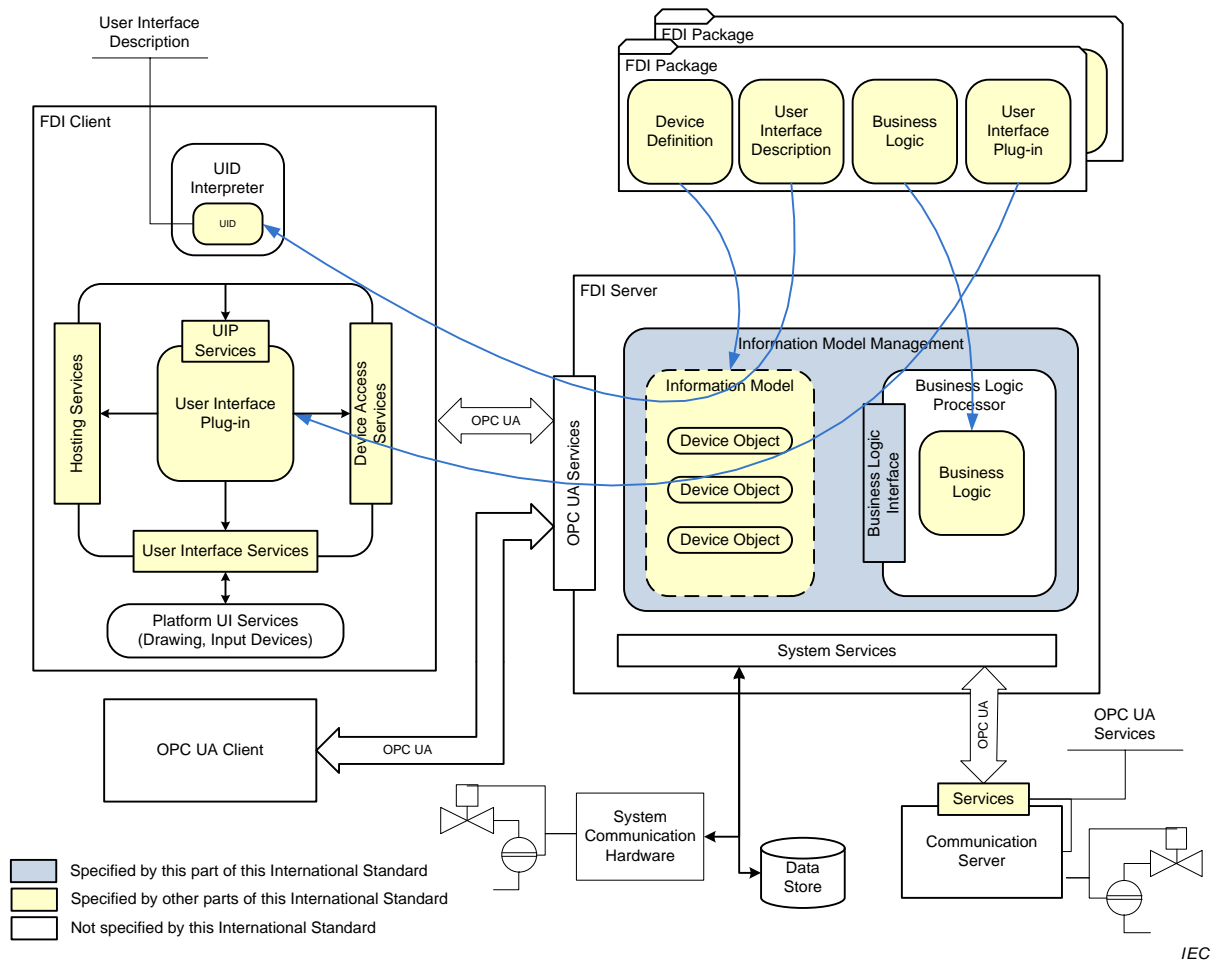
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# FIELD DEVICE INTEGRATION (FDI) – Part 3: FDI Server

## 1 Scope

This part of IEC 62769 specifies the FDI Server. The overall FDI architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this figure.



**Figure 1 – FDI architecture diagram**

## 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61804 (all parts), *Function blocks (FB) for process control and Electronic Device Description Language (EDDL)*